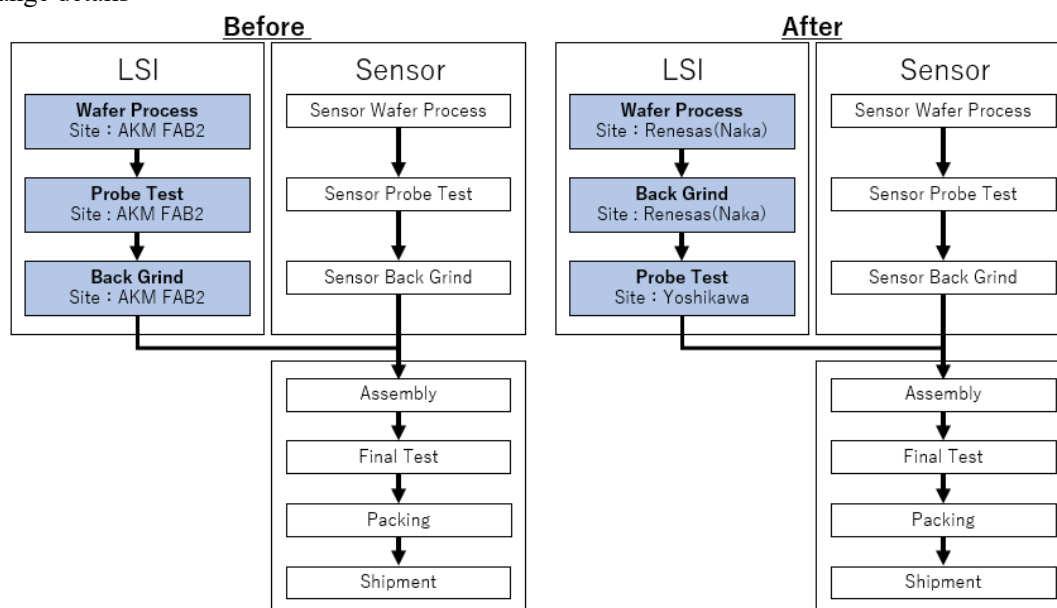




Product / Process Change Notice

The fire in FAB2(Nobeoka Plant) that occurred on October 20, 2020 caused significant damage to the facility. Therefore, AKM is hereby announcing the change of the site as below. In addition, we also change the resin for the purpose of improving the stability of production capacity. This is a change approval request which describes the change details and products affected. For the above reasons, the data sheet has been revised, so we will inform it as well.

◆Change details



◆Site: Before Change

Fab2: AKM Nobeoka Factory
5-4960 Nakagawara-cho, Nobeoka-shi, Miyazaki, Japan

◆Site: After Change

< Wafer Process, Back Grind Process >

Renesas (Naka): Renesas Electronics Corporation. Naka Fab
751, Horiguchi, Hitachinaka-shi, Ibaraki, Japan

< Probe Test >

Yoshikawa: Yoshikawakogyo RF Semicon Co., Ltd. Shintomi Fab
4637-1, Kamitonda, Shintomi-cho, Koyu-gun, Miyazaki, Japan

◆Proposed First ship date

February 2022

◆ Affected Product

| AKM Part No | Your Company's Part No |
|-------------|------------------------|
| CZ3A01 | |
| CZ3A02 | |
| CZ3A03 | |
| CZ3A04 | |
| CZ3A05 | |
| CZ3A06 | |
| CZ3A07 | |
| CZ3AG1 | |
| CZ3AG2 | |
| CZ3AG3 | |
| CZ3AG4 | |
| CZ3AG5 | |
| CZ3AG6 | |
| CZ3AG7 | |

If you agree to the foregoing conditions, please indicate your acknowledgement and acceptance by putting the signature of your authorized representative in the space provided below and return one original to us.

Sincerely yours,



Naoyuki Kurita
Vice President

Accepted and Agreed by:

Name:

Title:

Date: